



MOSFETs Silicon 500V N-Channel MOS

■ Applications

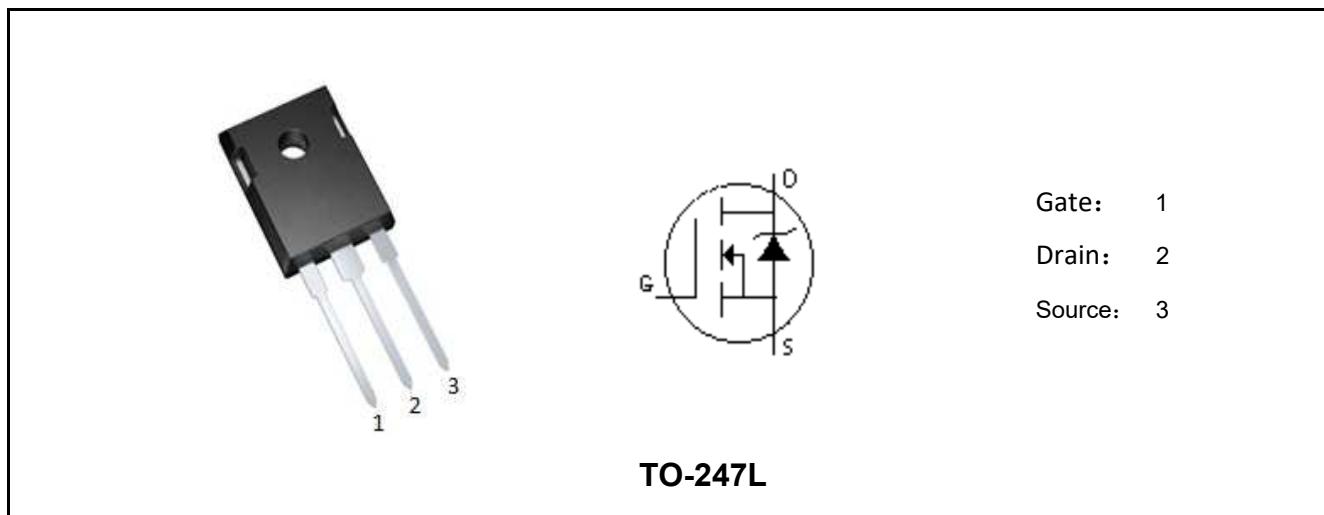
- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

■ Features

- Multi-Epi process SJ-FET
- Low $R_{DS(ON)}$
- Ultra Low Gate Charge
- RoHS and Halogen-Free Compliant
- 100% UIS and RG Tested

■ Product Summary

$V_{DS} @ T_{j,max}$	550	V
I_D	50	A
$R_{DS(ON)} ,Typ@10V$	58	mΩ
Q_g	62	nC



Marking	Package	Packaging	Min. package quantity
MSL070R50CFD2	TO-247	Tube	450





■ Absolute Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	± 30	V
Continuous Drain Current $T_c=25^\circ\text{C}$ (Note 1)	I_D	50	A
Continuous Drain Current $T_c=100^\circ\text{C}$ (Note 1)		30	
Drain Current-Pulsed (Note 1)	I_{DM}	180	A
Total Dissipation	P_D	446	W
Junction Temperature	T_j	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55-150	$^\circ\text{C}$
Single Pulse Avalanche Energy (Note 2)	E_{AS}	720	mJ

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

■ Thermal Characteristics

Parameter	Symbol	Max	Unit
Maximum Junction-to-Case	$R_{\theta JC}$	0.3	$^\circ\text{C}/\text{W}$
Maximum Junction-to-Ambient	$R_{\theta JA}$	40	$^\circ\text{C}/\text{W}$

Note 1: Ensure that the channel temperature does not exceed 150°C .

Note 2: $V_{DD}=100\text{V}$, $T_{ch}=25^\circ\text{C}$ (initial), $L=5\text{mH}$, $R_g=25\Omega$.

Note: This transistor is sensitive to electrostatic discharge and should be handled with care.



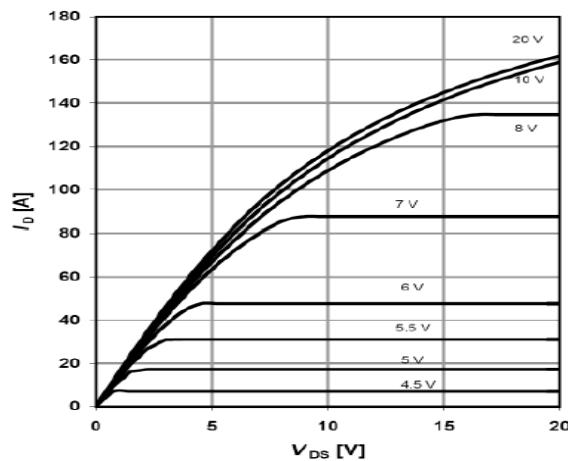
■ Electrical Characteristics (T_c=25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Parameters						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	500	-	-	V
		T _j =150°C	550	-	-	
Drain-Source Leakage Current	I _{DSS}	V _{DS} =500V, V _{GS} =0V	-	-	5	uA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =250uA	2	3	4	V
Drain-Source On Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =25A	-	58	70	mΩ
		T _j =150°C	-	140	-	
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1.0MHz	-	3100	-	pF
Output Capacitance	C _{oss}		-	3000	-	pF
Reverse Transfer Capacitance	C _{rss}		-	65	-	pF
Gate Resistance	R _g	V _{DS} =0V, V _{GS} =0V, f=1.0MHz	-	11	-	Ω
Switching Paramters						
Turn-On Delay Time	t _{d(on)}	V _{DS} =400V, I _D =25A, V _{GS} =13V, R _G =3.4Ω	-	21	-	ns
Turn-On Rise Time	t _r		-	14	-	ns
Turn-Off Delay Time	t _{d(off)}		-	145	-	ns
Turn-Off Fall Time	t _f		-	25	-	ns
Total Gate Charge	Q _g	V _{DS} =400V, I _D =25A, V _{GS} =10V	-	62	-	nC
Gate-Source Charge	Q _{gs}		-	13	-	nC
Gate-Drain Charge	Q _{gd}		-	20	-	nC
Source-Drain Characteristics						
Max. Diode Forward Cuurent	I _S	V _{GS} =0V, I _S =25A	-	-	50	A
Max. Pulsed Forward Cuurent	I _{SM}		-	-	180	A
Diode Forward Voltage	V _{sd}	V _{GS} =0V, I _S =25A	-	0.9	1.5	V
Reverse Recovery Time	t _{rr}	V _R =400V, I _F =25A, di/dt=100A/us	-	130	-	ns
Reverse Recovery Charge	Q _{rr}		-	0.75	-	μC

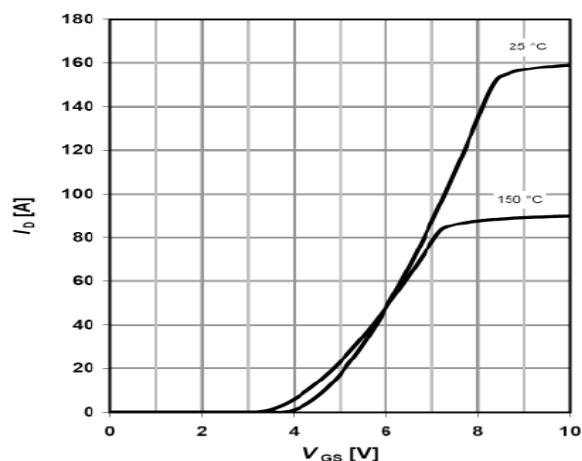




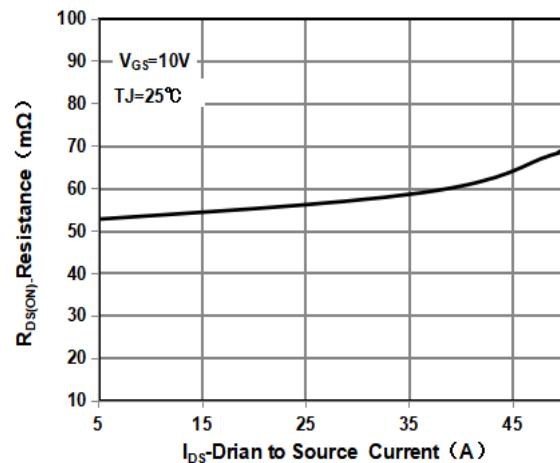
■ Characteristics Curves



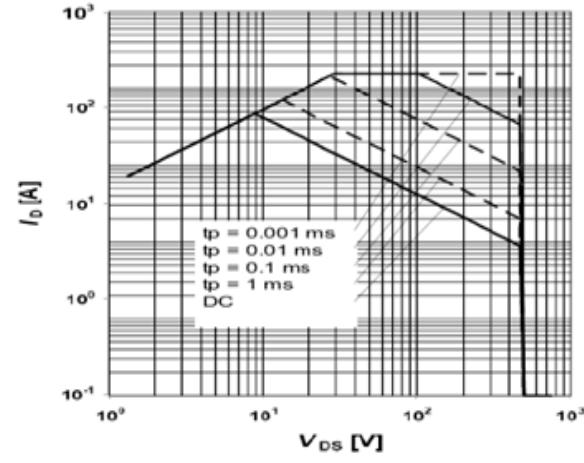
Output Characteristics



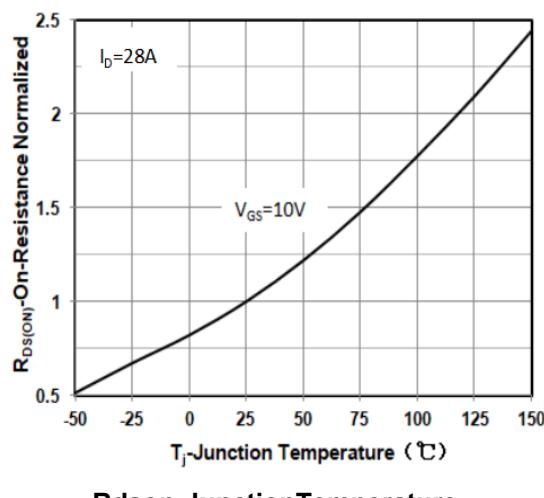
Transfer Characteristics



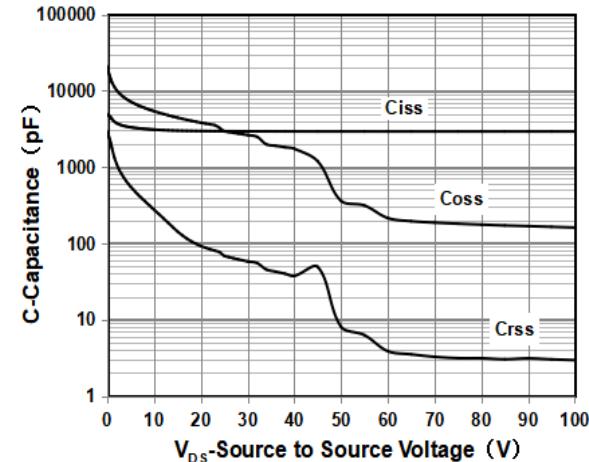
On Resistance Vs Drain Current



Maximum Safe Operating Area

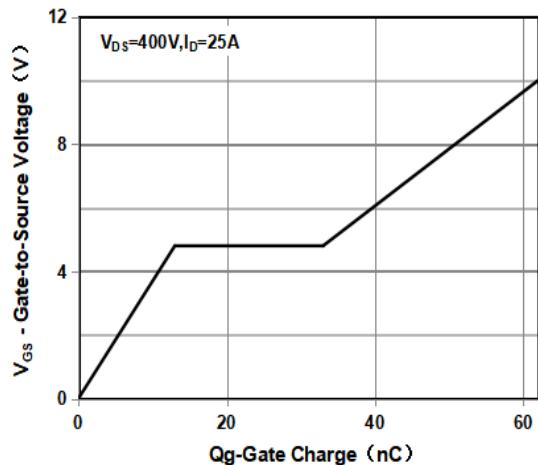


Rdson-JunctionTemperature

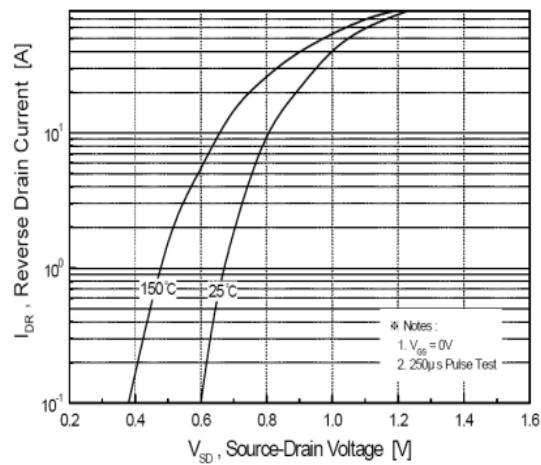


Capacitance

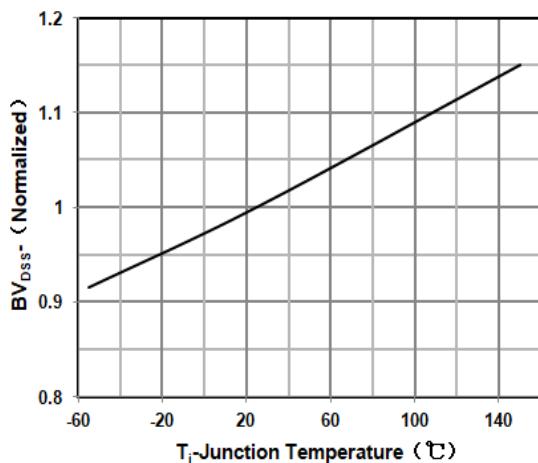




Gate Charge Waveform



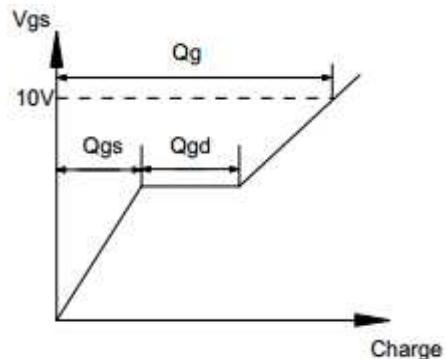
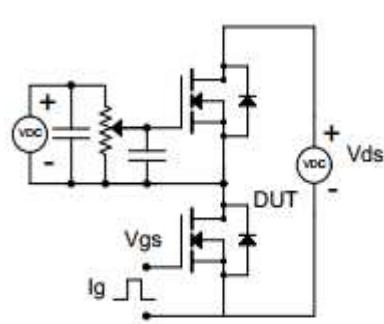
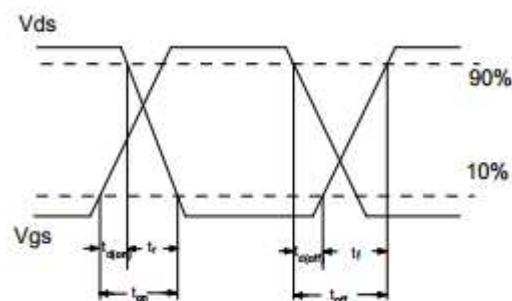
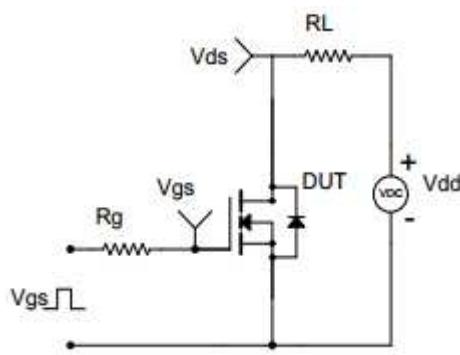
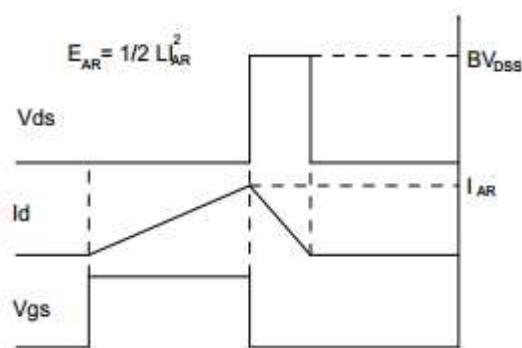
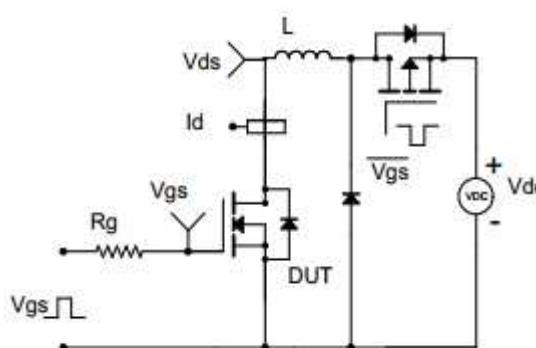
Source-Drain Diode Forward Voltage



Breakdown Voltage Vs Junction Temperature

Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



**■ Test Circuit & Waveform****Gate Charge Test Circuit & Waveform****Resistive Switching Test Circuit & Waveform****Unclamped Inductive Switching (UIS) Test Circuit & Waveform**



■ TO-247L Package Dimensions

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	4.80		5.20	E1	13.00		13.60
A1	2.20	2.40	2.60	E2	5.00		5.50
A2	1.85		2.15	E3	1.90		2.60
b	1.07		1.33	e		5.44	
b2	1.90		2.16	L	19.30		19.90
b4	2.90		3.20	L1	3.75	3.95	4.15
c	0.52		0.68	ΦP	3.40		3.80
D	20.70		21.30	ΦP1	7.00		7.40
D1	16.15		16.95	S	6.04	6.15	6.30
E	15.50		16.10				

